

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6957361

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DANIEL E. KILLIAN	09/24/2019
SIVARAM BALASUBRAMANIAN	09/25/2019
KENDAL R. HARRIS	09/25/2019
CHANDRESH R. CHAUDHARI	09/25/2019
RECEIVING PARTY DATA	
Name:	ROCKWELL AUTOMATION TECHNOLOGIES, INC.
Street Address:	1 ALLEN-BRADLEY DRIVE
City:	MAYFIELD HEIGHTS
State/Country:	OHIO
Postal Code:	44124
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17496072
CORRESPONDENCE DATA	
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Address Line 2:	THE HALLE BUILDING - 5TH FLOOR
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ATTORNEY DOCKET NUMBER:	ROKZ 200222US02
NAME OF SUBMITTER:	STEVEN HAAS
SIGNATURE:	/Steven Haas/
DATE SIGNED:	10/07/2021
Total Attachments: 8	
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2019P-081-US - ASSIGNMENT BY INVENTORS

DANIEL E. KILLIAN, SIVARAM BALASUBRAMANIAN,
KENDAL R. HARRIS and CHANDRESH R. CHAUDHARI

(Inventors) have invented

**DISTRIBUTED MODULAR INPUT/OUTPUT (I/O) SYSTEM WITH
REDUNDANT ETHERNET BACKPLANE NETWORKS FOR IMPROVED
FAULT TOLERANCE**

(the Inventions), as described in:

U.S. Patent Application Ser. No. 16/584,194, filed September 26, 2019 (the Application).

Rockwell Automation Technologies, Inc. (Assignee), an Ohio Corporation with a principal place of business at 1 Allen-Bradley Drive, Mayfield Heights, Ohio 44124, is desirous of acquiring the entire right, title, and interest in the Inventions and the Application. Any reference in this assignment to the Assignee encompasses the successors, legal representatives, and assigns of the Assignee.

For good and sufficient consideration, the receipt of which is hereby acknowledged, Inventors hereby transfer to Assignee the entire right, title, and interest in the Inventions and the Application, and in all patents and patent applications covering the Inventions or resulting from the Application, including all provisional, non-provisional, continuation, continuation-in-part, divisional, reissue, reexamination, foreign, and PCT applications, and any patents resulting from these applications, in the United States and in all foreign countries, including in particular the rights of priority originating from the Application.

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Inventors hereby authorize the Director of the U.S. Patent and Trademark Office and the empowered officials of all other governments to issue all patents covering the Inventions or resulting from the Application, to the Assignee.

Inventors hereby agree to carry out in good faith the intent and purpose of this assignment; to communicate to Assignee any facts relating to the Inventions, the Application, and any patents and applications that cover the Inventions or result from

Outside Counsel Ref. No. ROKZ 200222US01

RA Ref. No. 2019P-081-US

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The Inventors executed this assignment as of the dates indicated below:

Date: 09/24/2019

Daniel E Killian

Daniel E Killian (Sep 24, 2019)

DANIEL E. KILLIAN

Date: _____

SIVARAM BALASUBRAMANIAN

Date: _____

KENDAL R. HARRIS

Date: _____

CHANDRESH R. CHAUDHARI

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DANIEL E. KILLIAN

Date: 09/25/2019

Sivaram Balasubramanian

SIVARAM BALASUBRAMANIAN

SIVARAM BALASUBRAMANIAN

Date: _____

KENDAL R. HARRIS

Date: _____

CHANDRESH R. CHAUDHARI

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Date: _____

SIVARAM BALASUBRAMANIAN

Date: 09/25/2019

Kendal R. Harris
Kendal R. Harris, III

KENDAL R. HARRIS

Date: _____

CHANDRESH R. CHAUDHARI

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Chandresh R. Chaudhari
executed on 09/25/2019

CHANDRESH R. CHAUDHARI